# **<u>MOSFET</u>** – Power, Single N-Channel 80 V, 3.7 mΩ, 123 A

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS6H818NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAYIMI IM DATINGS /T 05°C uploss otherwise noted)



# **ON Semiconductor®**

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V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
80 V	$3.7~\mathrm{m}\Omega$ @ 10 V	123 A

D (5,6)

MAXIMUM RATINGS (T <sub>J</sub> = 25°C unless otherwise noted)							
Parameter			Value	Unit			
Drain-to-Source Voltage			80	V			
ate-to-Source Voltage			±20	V			
Steady	$T_{C} = 25^{\circ}C$	۱ <sub>D</sub>	123	А			
	T <sub>C</sub> = 100°C		87				
State	$T_{C} = 25^{\circ}C$	PD	136	W			
	$T_{\rm C} = 100^{\circ}{\rm C}$		68				
	$T_A = 25^{\circ}C$	۱ <sub>D</sub>	20	А			
Steady State	T <sub>A</sub> = 100°C		14				
	$T_A = 25^{\circ}C$	PD	3.8	W			
	T <sub>A</sub> = 100°C		1.9				
T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	900	А			
Operating Junction and Storage Temperature			–55 to + 175	°C			
Source Current (Body Diode)			113	А			
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 9.3 A$ )			731	mJ			
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			260	°C			
	neter e Steady State Steady State $T_A = 25$ Storage T biode) Source Av- oldering F	neter e T <sub>C</sub> = 25°C T <sub>C</sub> = 100°C T <sub>A</sub> = 25°C T <sub>A</sub> = 100°C	Symbol       e     Symbol       e     V <sub>DSS</sub> a $T_C = 25^{\circ}C$ Ip       Steady $T_C = 100^{\circ}C$ Ip       Steady $T_C = 100^{\circ}C$ Pp       T_C = 100^{\circ}C     Tp       Steady $T_A = 25^{\circ}C$ Ip       Steady $T_A = 25^{\circ}C$ Ip       T_A = 100^{\circ}C     Tp     Ip       T_A = 25^{\circ}C, t_p = 10 \mu s     Ip       Storage Temperature     Tj, Tstg       biode)     Is       Source Avalanche     EAS       oldering Purposes     TL	Symbol       Value         e       V <sub>DSS</sub> 80         e       V <sub>DSS</sub> 80         e       V <sub>GS</sub> $\pm 20$ steady       T <sub>C</sub> = 25°C       I <sub>D</sub> 123         Steady       T <sub>C</sub> = 100°C       R7       87         T <sub>C</sub> = 100°C       PD       136       68         T <sub>A</sub> = 25°C       PD       136       14         T <sub>A</sub> = 25°C       PD       3.8       1.9         T <sub>A</sub> = 25°C       PD       3.8       1.9         T <sub>A</sub> = 100°C       I <sub>DM</sub> 900       3.8       1.9         T <sub>A</sub> = 25°C, t <sub>p</sub> = 10 µs       I <sub>DM</sub> 900       3.8       1.9         T <sub>A</sub> = 25°C, t <sub>p</sub> = 10 µs       I <sub>DM</sub> 900       3.8       1.9         Storage Temperature       I <sub>S</sub> 113       3.8       3.8       3.1         Source Avalanche       E <sub>AS</sub> 731       3.1         oldering Purposes			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

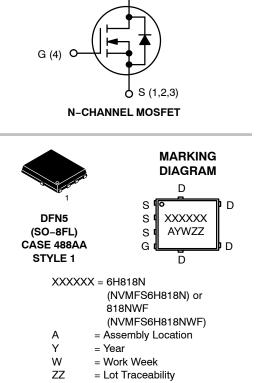
#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.1	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



**ORDERING INFORMATION** 

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

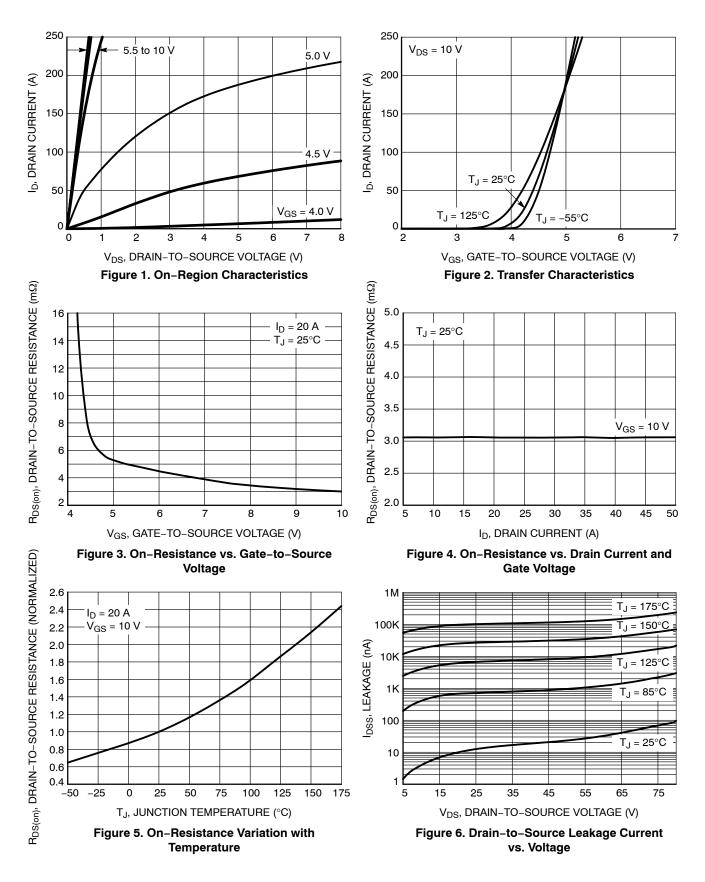
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS	-							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		80			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / TJ				39		mV/°C	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V,$ $T_{J} = 25^{\circ} C$				10		
		V <sub>DS</sub> = 80 V	T <sub>J</sub> = 125°C			100	μΑ	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = 20 V				100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub>	= 190 μA	2.0		4.0	V	
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				7.0		mV/°C	
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A		3.1	3.7	mΩ	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> =15 V, I <sub>D</sub> = 50 A			170		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE			-				
Input Capacitance	C <sub>ISS</sub>	$V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}, V_{DS} = 40 \text{ V}$ $V_{GS} = 10 \text{ V}, V_{DS} = 40 \text{ V}; \text{ I}_{D} = 50 \text{ A}$			3100		pF	
Output Capacitance	C <sub>OSS</sub>				440			
Reverse Transfer Capacitance	C <sub>RSS</sub>				20			
Total Gate Charge	Q <sub>G(TOT)</sub>				46			
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 40 V; I <sub>D</sub> = 50 A			9.0		nC	
Gate-to-Source Charge	Q <sub>GS</sub>				15			
Gate-to-Drain Charge	Q <sub>GD</sub>				8.0			
Plateau Voltage	V <sub>GP</sub>				5.0		V	
SWITCHING CHARACTERISTICS (Note 5	5)			-				
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 64 V, I <sub>D</sub> = 50 A, R <sub>G</sub> = 2.5 $\Omega$			22		- ns	
Rise Time	tr				98			
Turn-Off Delay Time	t <sub>d(OFF)</sub>				49			
Fall Time	t <sub>f</sub>				21			
DRAIN-SOURCE DIODE CHARACTERIS	TICS			-				
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.8	1.2		
		$I_{\rm S} = 20 \rm A$	T <sub>J</sub> = 125°C		0.7		V	
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dIS/dt = 100 A/µs, I <sub>S</sub> = 50 A			63		ns	
Charge Time	ta				31			
Discharge Time	t <sub>b</sub>				32			
Reverse Recovery Charge	Q <sub>RR</sub>				55		nC	

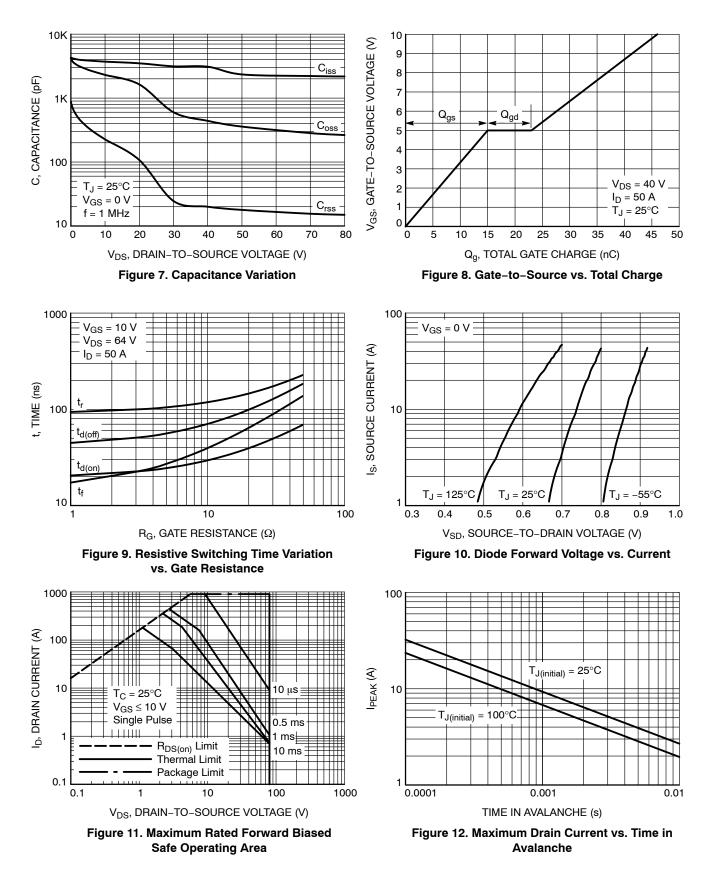
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ .

5. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



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## **TYPICAL CHARACTERISTICS**

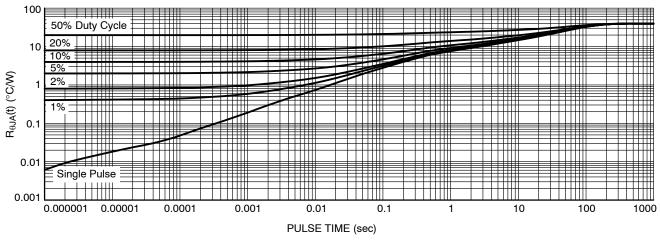


Figure 13. Thermal Response

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NVMFS6H818NT1G	6H818N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS6H818NWFT1G	818NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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